10-bit D-type flip-flop with 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

Rev. 4 — 23 November 2012

Product data sheet

1. General description

The 74LVC821A is a 10-bit D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. A clock input (pin CP) and an output enable input (pin \overline{OE}) are common to all flip-flops. The ten flip-flops store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition. When pin \overline{OE} is LOW, the contents of the ten flip-flops are available at the outputs.

When pin \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of the \overline{OE} inputs does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

2. Features and benefits

- 5 V tolerant inputs and outputs; for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Flow-through pinout architecture
- 10-bit positive edge-triggered register
- Independent register and 3-state buffer operation
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - ◆ MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

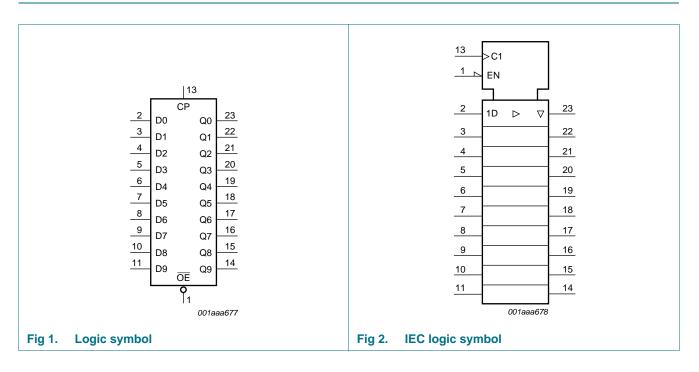


10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

3. Ordering information

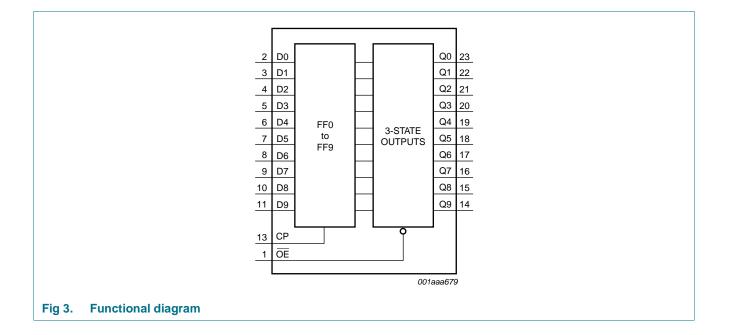
Type number	Package								
Type number	Раскаде		1	-					
	Temperature range	Name	Description	Version					
74LVC821AD	–40 °C to +125 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1					
74LVC821ADB	–40 °C to +125 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1					
74LVC821APW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1					
74LVC821ABQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm	SOT815-1					

4. Functional diagram



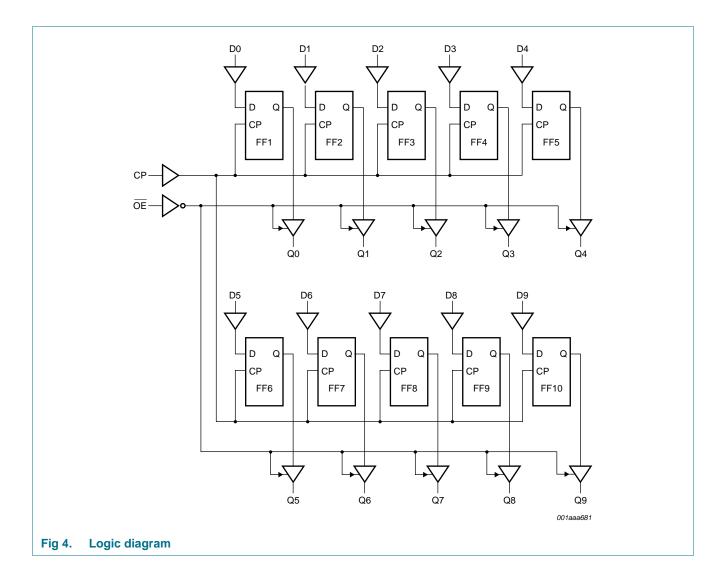
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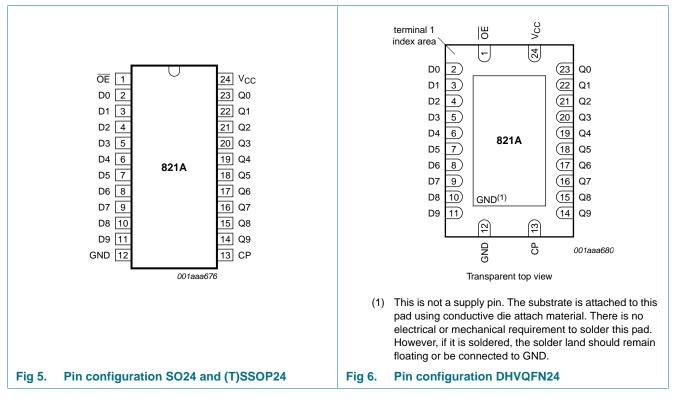
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10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
OE	1	output enable input (active LOW)
CP	13	clock input (LOW-to-HIGH, edge-triggered)
D[0:9]	2, 3, 4, 5, 6, 7, 8, 9, 10, 11	data input
Q[0:9]	23, 22, 21, 20, 19, 18, 17, 16, 7	15, 14 3-state flip-flop output
GND	12	ground (0 V)
V _{CC}	24	supply voltage

10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

6. Functional description

Table 3.Function table

Operating mode	Input		Internal	Output	
	OE	СР	Dn	flip-flops	Qn
Load and read register	L	\uparrow	I	L	L
	L	\uparrow	h	Н	Н
Load register and disable outputs	Н	\uparrow	I	L	Z
	Н	\uparrow	h	Н	Z
Hold	L	H or L	Х	NC	NC

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time before the LOW-to-HIGH CP transition

L = LOW voltage level

I = LOW voltage level one set-up time before the LOW-to-HIGH CP transition

Z = high-impedance OFF-state

 \uparrow = LOW-to-HIGH clock transition

X = don't care

NC = no change

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	V_{O} > V_{CC} or V_{O} < 0 V	-	±50	mA
Vo	output voltage	HIGH or LOW state	[2] -0.5	V _{CC} + 0.5	V
		3-state	<u>[2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u> _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO24 package: above 70 °C derate linearly with 8 mW/K.
 For SSOP24 and TSSOP24 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN24 package: above 60 °C derate linearly with 4.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating of	conditions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC} supply voltage			1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	HIGH or LOW state	0	-	V _{CC}	V
		3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
	rate	$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C to	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	V _{IL} LOW-level input voltage	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
		V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35\times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V	
V _{OH}	V _{OH} HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$						
		$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I_{O} = 100 µA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		I_0 = 8 mA; V_{CC} = 2.3 V	-	-	0.6	-	0.8	V
		I_0 = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

Symbol	Parameter	Conditions	-40	–40 °C to +85 °C			–40 °C to +125 °C	
			Min	Typ <mark>[1]</mark>	Max	Min	Мах	
I _{OZ}	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL}; \ V_{CC} = 3.6 \ V; \\ V_{O} = 5.5 \ V \text{ or } GND; \end{array}$	-	0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	0.1	±10	-	±20	μΑ
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A	-	0.1	10	-	40	μΑ
Δl _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A$	-	5	500	-	5000	μΑ
Cl	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V ₁ = GND to V _{CC}	-	5.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation	CP to Qn; see Figure 7	[2]						
	delay	$V_{CC} = 1.2 V$		-	18	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.4	8.6	17.1	2.3	19.7	ns
	V_{CC} = 2.3 V to 2.7 V		1.8	4.5	8.8	1.6	10.1	ns	
	$V_{CC} = 2.7 V$		1.5	4.1	8.5	2.2	11.0	ns	
	V_{CC} = 3.0 V to 3.6 V		1.5	3.8	7.3	2.0	9.5	ns	
t _{en} enable tim	enable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	20	-	-	-	ns
		V _{CC} = 1.65 V		1.8	7.7	17.4	1.6	20.1	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.3	9.6	1.3	11.0	ns
		$V_{CC} = 2.7 V$		1.3	4.4	8.8	2.4	11.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.5	7.6	1.5	9.5	ns
t _{dis}	disable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	9.0	-	-	-	ns
		V _{CC} = 1.65 V		2.5	4.4	10.4	1.8	12.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.4	5.9	0.6	6.8	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.8	2.2	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.0	6.2	1.9	8.0	ns

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Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _W	pulse width	clock HIGH or LOW; see Figure 7							
		V_{CC} = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.3	-	-	3.3	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		3.3	1.7	-	3.3	-	ns
t _{su}	set-up time	Dn to CP; see Figure 8							
		V_{CC} = 1.65 V to 1.95 V		3.5	-	-	3.5	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		0.9	-	-	0.9	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.9	0.6	-	1.9	-	ns
t _h	hold time	Dn to CP; see Figure 8							
		V_{CC} = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.5	-	-	1.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	0.0	-	1.5	-	ns
f _{max}	maximum	see Figure 7							
	frequency	V_{CC} = 1.65 V to 1.95 V		100	-	-	80	-	MHz
		V_{CC} = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	200	-	120	-	MHz
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	dissipation	V_{CC} = 1.65 V to 1.95 V		-	12.5	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	14.7	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	16.6	-	-	-	pF

Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 10</u>.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

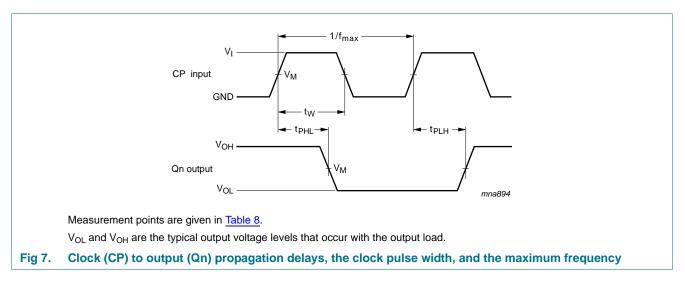
 V_{CC} = supply voltage in Volts

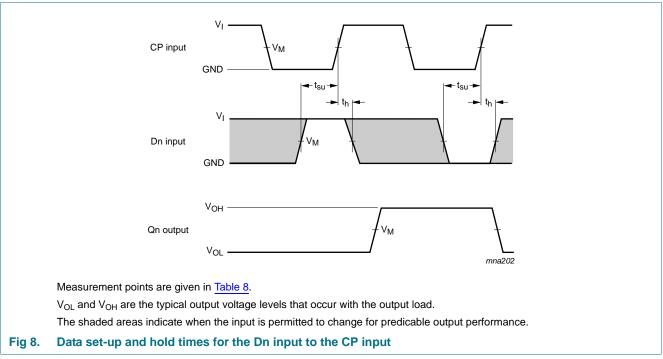
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs

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11. Waveforms





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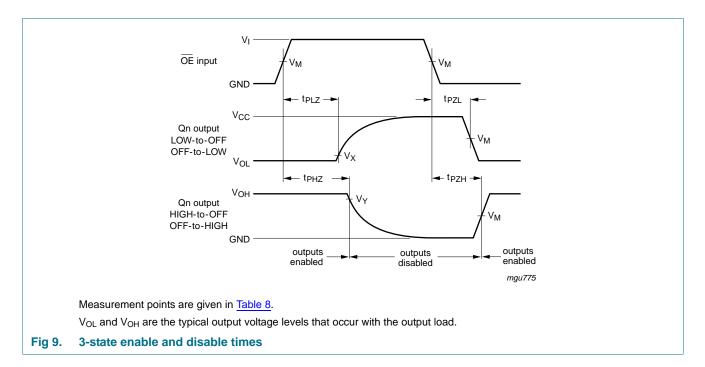


Table 8. Measurement points

Supply voltage	Input		Output	Output				
V _{CC}	VI	V _M	V _M	V _X	V _Y			
1.2 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.3 V to 2.7 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V			

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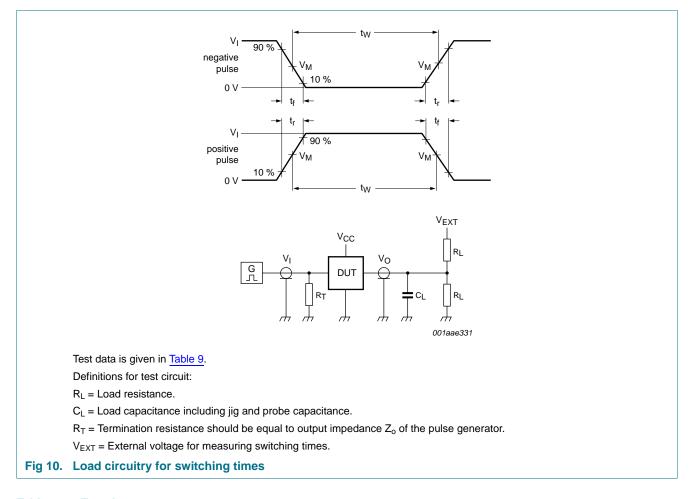


Table 9. Test data	a								
Supply voltage	Input		Load		V _{EXT}	V _{EXT}			
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}		
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND		
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND		

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12. Package outline

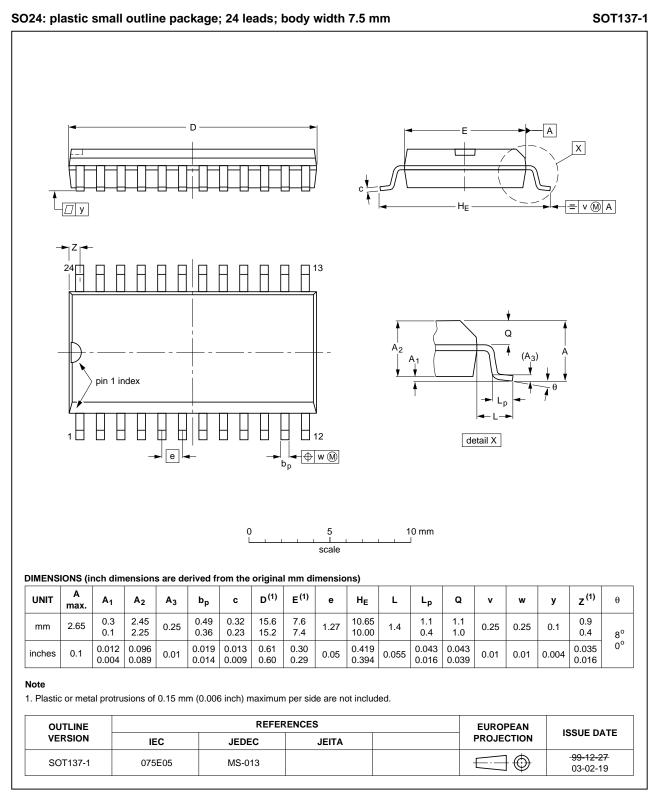


Fig 11. Package outline SOT 137-1 (SO24)

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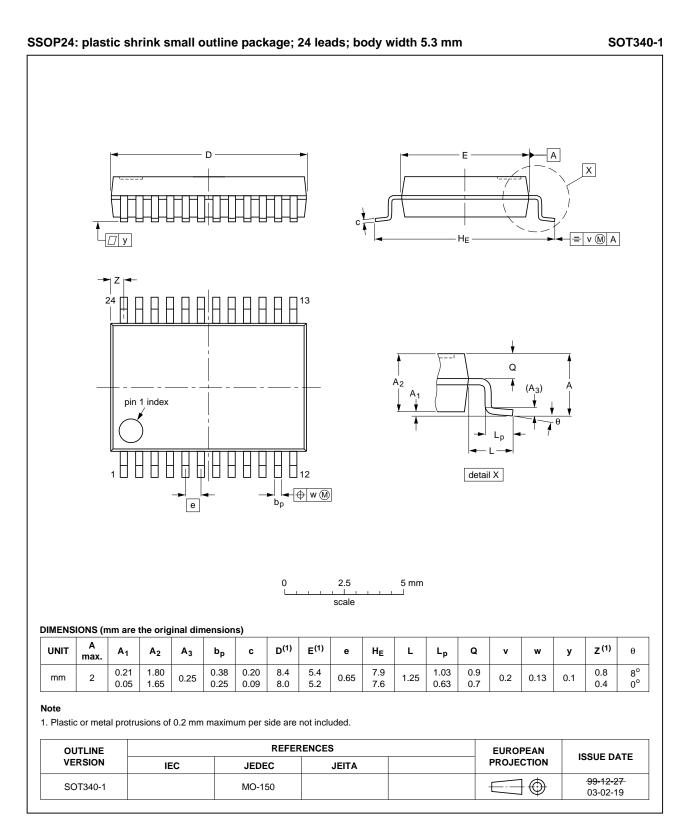


Fig 12. Package outline SOT 340-1 (SSOP24)

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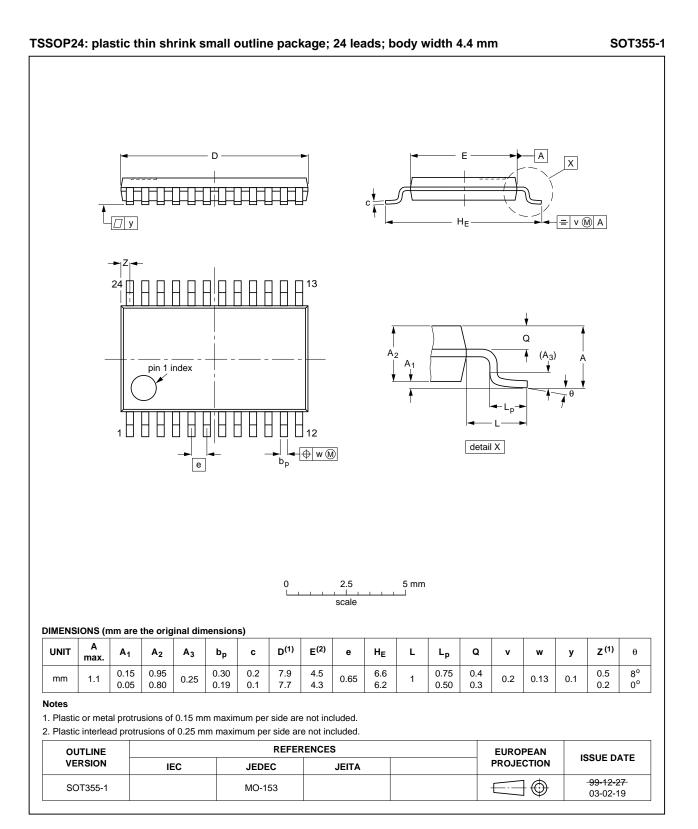
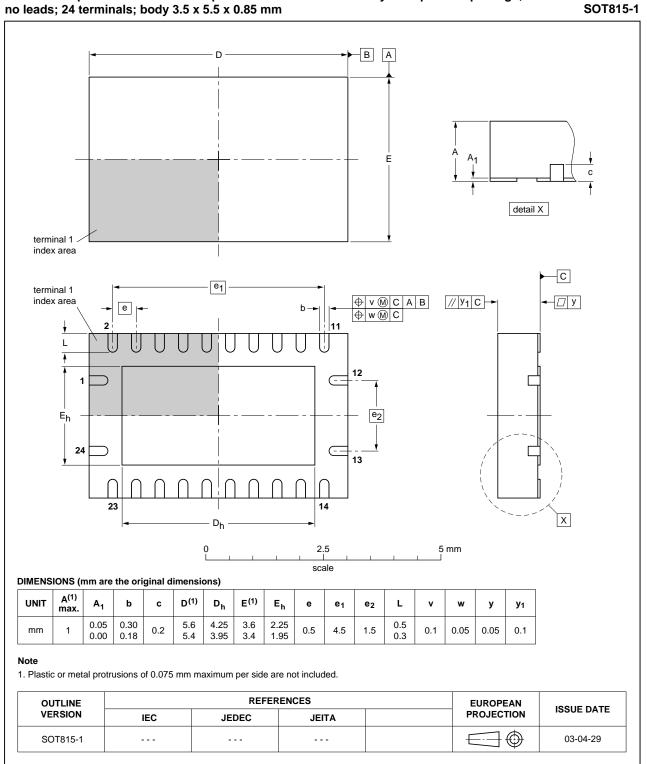


Fig 13. Package outline SOT 355-1 (TSSOP24)

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

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Fig 14. Package outline SOT 815-1 (DHVQFN24)

10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

13. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision	history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC821A v.4	20121123	Product data sheet	-	74LVC821A v.3		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts have been adapted to the new company name where appropriate. 					
	• <u>Table 4</u> , <u>Table 5</u> , <u>Table 6</u> , <u>Table 7</u> , and <u>Table 8</u> : values added for lower voltage ranges.					
74LVC821A v.3	20040511	Product specification	-	74LVC821A v.2		
74LVC821A v.2	20040415	Product specification	-	74LVC821A v.1		
74LVC821A v.1	19980925	Product specification	-	-		

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status [3] information is available on the Internet at URL http://www.nxp.com

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10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

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